&TDK Multilayer Ceramic Chip Capacitors

CGA4J4C0G2W272J125AE



TDK item description CGA4J4C0G2W272JT***S

Applications	Automotive Grade	, m
	Mid Voltage (100 to 630V)	
Feature	Soft Termination	
	AEC-Q200 AEC-Q200	1.0
Series	CGA4(2012) [EIA 0805]	B Dimensions in mm
Status	Production	

	Size
Length(L)	2.00mm +0.45,-0.20mm
Width(W)	1.25mm +0.25,-0.20mm
Thickness(T)	1.25mm +0.25,-0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.50mm Min.
Recommended Land Pattern (PA)	1.00mm to 1.30mm(Flow Soldering)
	0.90mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.00mm to 1.20mm(Flow Soldering)
	0.70mm to 0.90mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.80mm to 1.10mm(Flow Soldering)
	0.90mm to 1.20mm(Reflow Soldering)

Electrical Characteristics			
Capacitance	2.7nF ±5%		
Rated Voltage	450VDC		
Temperature Characteristic	C0G(0±30ppm/°C)		
Q (Min.)	1000		
Insulation Resistance (Min.)	10000ΜΩ		

Other		
Coldering Mathed	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	Yes	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000pcs	

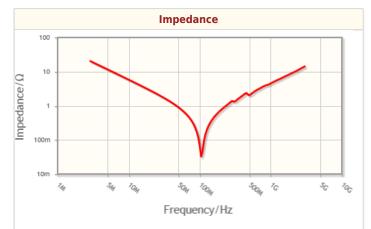
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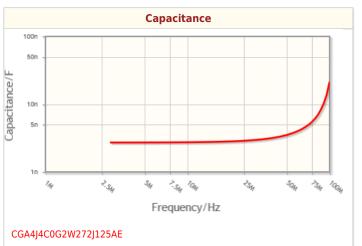
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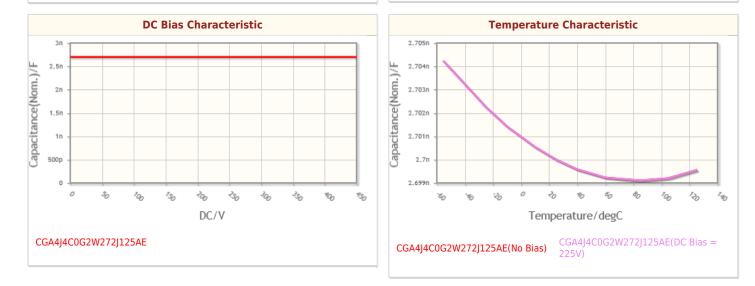




Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



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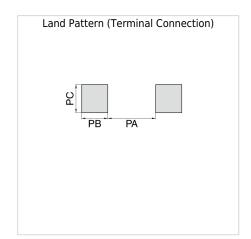
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Associated Images



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